



### COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

## **Product Summary**

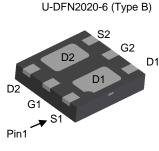
Device	BV <sub>DSS</sub>	Rds(on) max	I <sub>D MAX</sub> Т <sub>А</sub> = +25°С
		$34m\Omega @ V_{GS} = 4.5V$	5.1A
Q1	12V	$40m\Omega @ V_{GS} = 2.5V$	4.7A
N-Channel		50mΩ @ V <sub>GS</sub> = 1.8V	4.2A
		70mΩ @ V <sub>GS</sub> = 1.5V	3.6A
		$59m\Omega @ V_{GS} = -4.5V$	-3.9A
Q2	-12	81mΩ @ V <sub>GS</sub> = -2.5V	-3.3A
P-Channel		$115m\Omega @ V_{GS} = -1.8V$	-2.8A
		$215m\Omega @ V_{GS} = -1.5V$	-2.0A

# **Description and Applications**

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Load Switch
- **Power Management Functions**
- Portable Power Adaptors





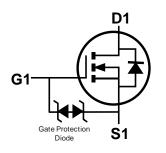
Bottom View

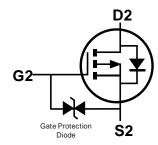
#### Features

- Low On-Resistance
- Low Input Capacitance
- Low Profile, 0.6mm Max Height
- **ESD** Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- **PPAP Capable (Note 4)**

### **Mechanical Data**

- Case: U-DFN2020-6 (Type B)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020 •
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @4)
- Terminals Connections: See Diagram Below
- Weight: 0.0065 grams (Approximate)





N-CHANNEL MOSFET

P-CHANNEL MOSFET

Internal Schematic

### Ordering Information (Note 5)

Part Number	Case	Packaging
DMC1030UFDBQ-7	U-DFN2020-6 (Type B)	3000/Tape & Reel
DMC1030UFDBQ-13	U-DFN2020-6 (Type B)	10000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.</li>
 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product\_compliance\_definitions.html.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

D3

## Marking Information

Notes:

D3 = Produc YM = Date C Y = Year (ex M = Month (e
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D3 = Product Type Marking Code	
YM = Date Code Marking	
Y = Year (ex; D = 2016)	

x: 9 = September)

Date Code Key												
Year	201	5	2016		2017	20	18	2019		2020	2	2021
Code	С		D		E		F	G		Н		
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Symbol	Q1 N-CHANNEL	Q2 P-CHANNEL	Unit
Drain-Source Voltage			V <sub>DSS</sub>	12	-12	V
Gate-Source Voltage			V <sub>GSS</sub>	±8	±8	V
Continuous Drain Current (Note 6)	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	5.1 4.1	-3.9 -3.1	A
N-CHANNEL: V <sub>GS</sub> = 4.5V P-CHANNEL: V <sub>GS</sub> = -4.5V	t < 5s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	6.6 5.3	-5.0 -4.0	А
Maximum Continuous Body Diode Forward Curre	ent (Note 6)		Is	2	-1.7	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I <sub>DM</sub>	35	-25	A
Avalanche Current (L = 0.1mH)			I <sub>AS</sub>	5	-5	А
Avalanche Energy (L = 0.1mH)			E <sub>AS</sub>	4	4	mJ

# **Thermal Characteristics**

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 6)	Steady State	D-	1.36	W	
Total Fower Dissipation (Note 6)	t < 5s	PD	1.89	vv	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State		92		
Thermal Resistance, Junction to Amblent (Note 6)	t < 5s	R <sub>θJA</sub>	66	°C/W	
Thermal Resistance, Junction to Case (Note 6)	$R_{\theta JC}$	18			
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C	

## Electrical Characteristics Q1 N-CHANNEL (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

~	Symbol					
Characteristic		Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)				1	1	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	12	—	—	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current $T_J = +25^{\circ}C$	IDSS	—	—	1.0	μA	$V_{DS} = 12V, V_{GS} = 0V$
Gate-Source Leakage	IGSS	—	—	±10	μA	$V_{GS} = \pm 8V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.4	—	1	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
		_	17	34		$V_{GS} = 4.5V, I_D = 4.6A$
Static Drain-Source On-Resistance	Р	_	20	40	mΩ	$V_{GS} = 2.5V, I_D = 4.2A$
	R <sub>DS(ON)</sub>	_	24	50	11152	$V_{GS} = 1.8V, I_D = 3.8A$
		_	28	70		$V_{GS} = 1.5V, I_D = 1.5A$
Diode Forward Voltage	V <sub>SD</sub>		0.7	1.2	V	$V_{GS} = 0V, I_{S} = 4.8A$
DYNAMIC CHARACTERISTICS (Note 8)			•		•	·
Input Capacitance	C <sub>iss</sub>	_	1003	_	pF	
Output Capacitance	Coss	_	132	—	pF	$V_{DS} = 6V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	115	_	pF	
Gate Resistance	Rg	_	11.3	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = 4.5V)	0		12.2	_	nC	
Total Gate Charge (V <sub>GS</sub> = 8V)	Qg		23.1	_	nC	
Gate-Source Charge	Q <sub>gs</sub>		1.3	_	nC	$V_{DS} = 10V, I_D = 6.8A$
Gate-Drain Charge	Q <sub>gd</sub>		1.5	_	nC	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	4.4	—	ns	
Turn-On Rise Time	t <sub>R</sub>	_	7.4	_	ns	$V_{DD} = 6V, V_{GS} = 4.5V,$
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	18.8	—	ns	$R_L = 1.1\Omega, R_G = 1\Omega$
Turn-Off Fall Time	t <sub>F</sub>	_	4.9	—	ns	
Body Diode Reverse Recovery Time	t <sub>RR</sub>	_	7.6	—	ns	$I_{S} = 5.4A$ , dI/dt = 100A/µs
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>		0.9		nC	I <sub>S</sub> = 5.4A, dI/dt = 100A/µs

 Notes:
 6. Device mounted on 1" x 1" FR-4 PCB with high coverage 2oz. Copper, single sided.

 7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.





85°C

25°C

1.5

 $T_{A}^{I} = 150^{\circ}C$ 

 $T_A = 85°C$ 

T<sub>A</sub> = -55°C

16 18 20

V<sub>GS</sub> = 2.5V

 $I_{D} = 5.0A$ 

100 125

75

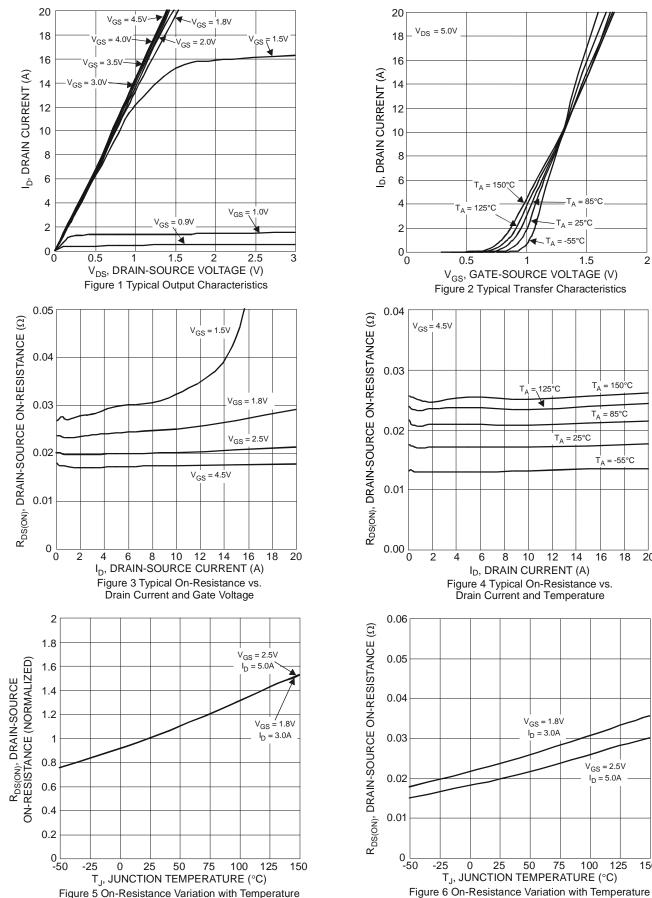
2

-55

 $T_A = 25^{\circ}C$ 

12

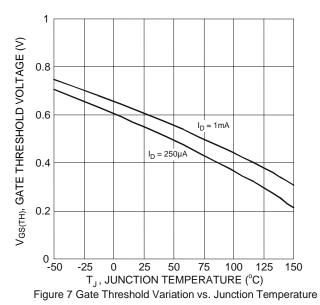
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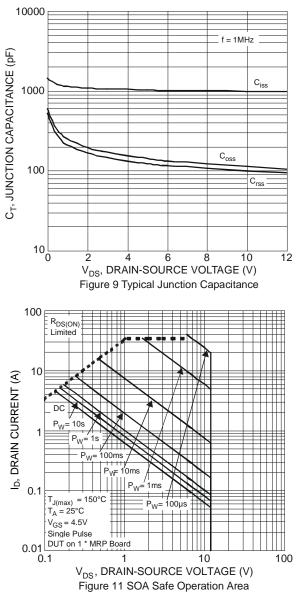


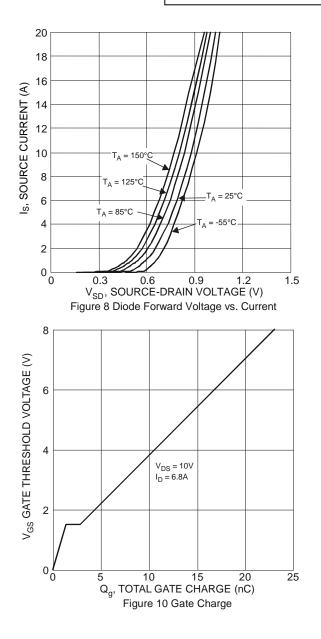
150



# DMC1030UFDBQ





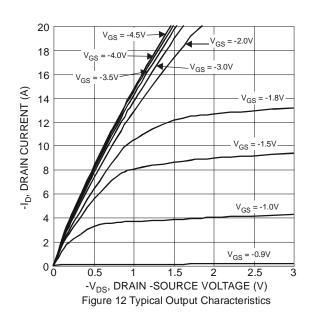


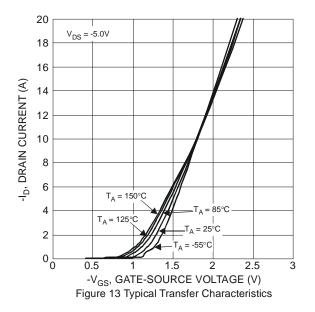


## Electrical Characteristics Q2 P-CHANNEL (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

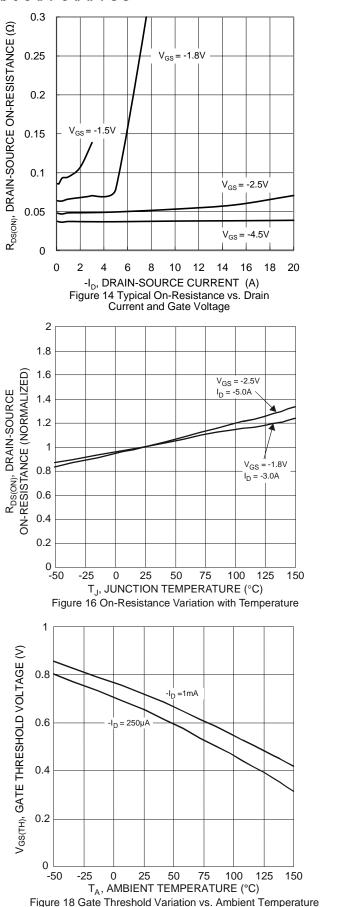
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)						1	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-12	_		V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	I <sub>DSS</sub>		_	-1.0	μA	$V_{DS} = -12V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>		_	±10	μA	$V_{GS} = \pm 8V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)			•	•	•	·	
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.4	—	-1	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$	
		_	37	59		$V_{GS} = -4.5V, I_D = -3.6A$	
Static Drain-Source On-Resistance			48	81	mΩ	V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -3.1A	
	Rds(on)		69	115	11152	V <sub>GS</sub> = -1.8V, I <sub>D</sub> = -2.6A	
			88	215		$V_{GS} = -1.5V, I_D = -0.5A$	
Diode Forward Voltage	V <sub>SD</sub>		-0.7	-1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = -3.7A	
DYNAMIC CHARACTERISTICS (Note 8)						·	
Input Capacitance	C <sub>iss</sub>	_	1028	_	pF		
Output Capacitance	C <sub>oss</sub>		285	_	pF	$V_{DS} = -6V$ , $V_{GS} = 0V$ , f = 1.0MHz	
Reverse Transfer Capacitance	C <sub>rss</sub>		254		pF	1 = 1:00012	
Gate Resistance	Rg		19.6		Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = -4.5V)			13		nC		
Total Gate Charge (V <sub>GS</sub> = -8V)	Qg		20.8		nC		
Gate-Source Charge	Q <sub>gs</sub>		1.8		nC	$-V_{DS} = -10V, I_{D} = -4.7A$	
Gate-Drain Charge	Q <sub>gd</sub>	_	4.5	_	nC	1	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	5.6	_	ns		
Turn-On Rise Time	t <sub>R</sub>		12.8		ns	$V_{DD} = -6V, V_{GS} = -4.5V,$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	30.7	—	ns	$R_L = 1.6\Omega, R_G = 1\Omega$	
Turn-Off Fall Time	t <sub>F</sub>	_	25.4	_	ns		
Body Diode Reverse Recovery Time	t <sub>RR</sub>	—	31.6	—	ns	I <sub>S</sub> = -3.6A, dl/dt = 100A/µs	
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	_	7.8	_	nC	I <sub>S</sub> = -3.6A, dI/dt = 100A/µs	

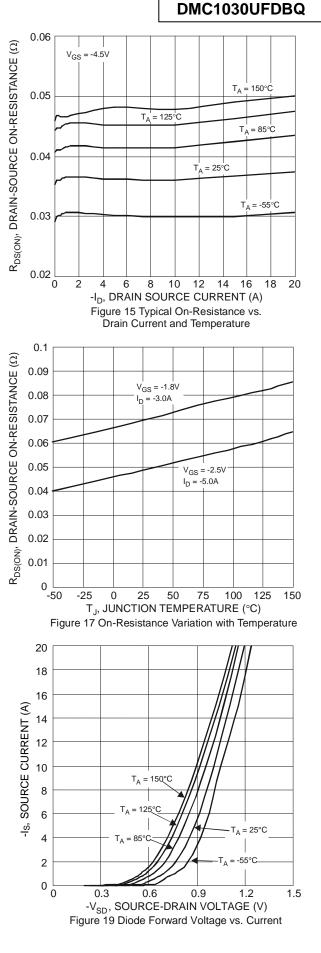
Notes: 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.









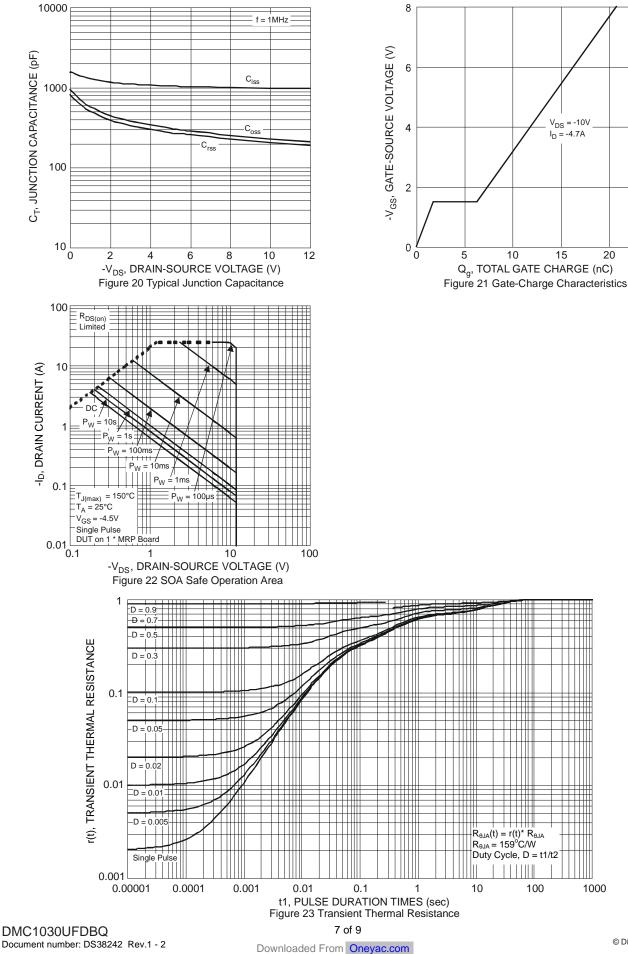




# DMC1030UFDBQ

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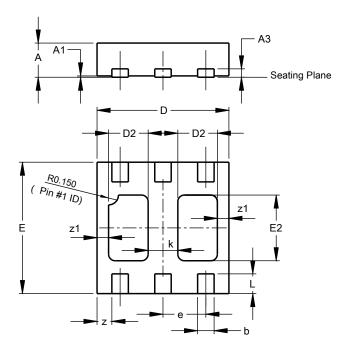


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# **Package Outline Dimensions**

Please see AP02001 at http://www.diodes.com/\_files/datasheets/ap02001.pdf for the latest version.



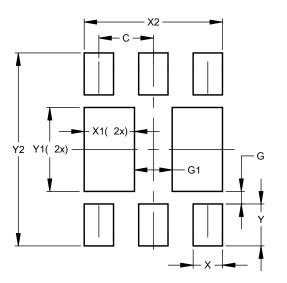
	U-DFN2020-6 Type B							
Dim	Min	Max	Тур					
Α	0.545	0.605	0.575					
A1	0.00	0.05	0.02					
A3	-	-	0.13					
b	0.20	0.30	0.25					
D	1.95	2.075	2.00					
D2	0.50	0.70	0.60					
е	-	-	0.65					
Е	1.95	2.075	2.00					
E2	0.90	1.10	1.00					
k	-	-	0.45					
L	0.25	0.35	0.30					
z	-	-	0.225					
z1	-	-	0.175					
All	Dimens	ions in	mm					

# Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/\_files/datasheets/ap02001.pdf for the latest version.

#### U-DFN2020-6 (Type B)

U-DFN2020-6 (Type B)



Dimensions	Value (in mm)
С	0.650
G	0.150
G1	0.450
Х	0.350
X1	0.600
X2	1.650
Ŷ	0.500
Y1	1.000
Y2	2.300



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